

REF. UNDER 37 C.F.R. § 1.116  
EXPEDITED PROCEDURE  
EXAMINING GROUP 1753

PATENT  
(5298-03500/PM99021)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:  
Lau

Serial No. 09/476,669

Filed: December 30, 1999

For: METHOD FOR FORMING A  
METALLIZATION STRUCTURE IN  
AN INTEGRATED CIRCUIT

Group Art Unit: 1753  
Examiner: Cantelmo, G.

Atty. Dkt. No. 5298-03500

I hereby certify that this correspondence is being deposited  
with the U.S. Postal Service with sufficient postage as First Class  
Mail in an envelope addressed to: Max A. Commissioner for  
Patents, Washington, D.C. 20231, on the date indicated below:

November 26, 2001  
Date

Kevin L. Daffer

AMENDMENT; RESPONSE AFTER FINAL REJECTION  
PURSUANT TO 37 CFR § 1.116

Box AF  
Commissioner for Patents  
Washington, D.C. 20231

Dear Sir/Madam:

This paper is submitted in response to the Office Action mailed September 26, 2001 to  
further highlight reasons why the application is in condition for allowance.

Please amend the case as follows.